

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7350759

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHOHEI YAMAZAKI	05/17/2022
HIROYUKI IZAWA	05/17/2022
TOSHIYUKI SUGIMOTO	05/13/2022
RECEIVING PARTY DATA	
Name:	SHOWA DENKO MATERIALS CO., LTD.
Street Address:	9-2, MARUNOUCHI 1-CHOME
City:	CHIYODA-KU, TOKYO
State/Country:	JAPAN
Postal Code:	100-6606
Name:	NATIONAL UNIVERSITY CORPORATION YAMAGATA UNIVERSITY
Street Address:	4-12, KOJIRAKAWAMACHI 1-CHOME
City:	YAMAGATA-SHI, YAMAGATA
State/Country:	JAPAN
Postal Code:	990-8560
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17775886
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	571-730-0167
Email:	USPTO@soei-patent.co.jp
Correspondent Name:	SOEI PATENT & LAW FIRM
Address Line 1:	1750 TYSONS BLVD, SUITE 1500
Address Line 4:	MCLEAN, VIRGINIA 22102
ATTORNEY DOCKET NUMBER:	FP20-1000-00US-HTC
NAME OF SUBMITTER:	BRYAN D. KIRKPATRICK
SIGNATURE:	/Bryan D. Kirkpatrick/

DATE SIGNED:	05/26/2022
Total Attachments: 2 source=Assignment_FP20-1000-00US-HTC#page1.tif source=Assignment_FP20-1000-00US-HTC#page2.tif	

ASSIGNMENTWhereas, I/we,
Name

Address

1) **Shohei YAMAZAKI**c/o Showa Denko Materials Co., Ltd.,
9-2, Marunouchi 1-chome,
Chiyoda-ku, Tokyo 100-6606 Japan2) **Hiroyuki IZAWA**c/o Showa Denko Materials Co., Ltd.,
9-2, Marunouchi 1-chome,
Chiyoda-ku, Tokyo 100-6606 Japan3) **Toshiyuki SUGIMOTO**c/o NATIONAL UNIVERSITY CORPORATION YAMAGATA UNIVERSITY,
4-12, Kojirakawamachi 1-chome,
Yamagata-shi, Yamagata 990-8560 Japanhereinafter called assignor(s), have invented certain improvements in
METHOD FOR DISPERSING CONDUCTIVE PARTICLES, AND ELECTROSTATIC ADSORPTION DEVICEand executed an application for Letters Patent of the United States of America therefor on even date herewith unless
otherwise indicated below:filed on May 11, 2022, Serial No. 17/775886; and

Whereas

Showa Denko Materials Co., Ltd.
9-2, Marunouchi 1-chome,
Chiyoda-ku, Tokyo 100-6606 Japanand, NATIONAL UNIVERSITY CORPORATION YAMAGATA UNIVERSITY
4-12, Kojirakawamachi 1-chome,
Yamagata-shi, Yamagata 990-8560 Japan(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States
patents to be obtained therefor;NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is
hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign,
transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to
this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States
which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of
Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and
assigns, in accordance with the terms of this Assignment;AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with
assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal
proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or
desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional,
continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its
successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being
understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and
assigns.In the event that the patent application filing date or serial number is not known at the time this Assignment is
executed, I/WE hereby grant permission to the attorneys of record in the patent application to fill in the filing date and/or
serial number above, and to record this Assignment after such information is added.INVENTORSDATE SIGNED

1):

Name :

Shohei Yamazaki

Shohei YAMAZAKI

2022. 5. 17

2):

Name :

Hiroyuki IZAWA

Hiroyuki IZAWA

2022. 5. 17

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)

Page 1 of 2

3) : Toshiyuki Sugimoto
Name : Toshiyuki SUGIMOTO

May 13, 2022